

## **Thin germanium oxynitride gate dielectric for germanium-based devices**

### **ABSTRACT OF THE INVENTION**

A method for producing thin, below 6nm of equivalent oxide thickness,  
5 germanium oxynitride layer on Ge-based materials for use as gate dielectric is disclosed.  
The method involves a two step process. First, nitrogen is incorporated in a surface layer  
of the Ge-based material. Second, the nitrogen incorporation is followed by an oxidation  
step. The method yields excellent thickness control of high quality gate dielectrics for Ge-  
based field effect devices, such as MOS transistors. Structures of devices having the thin  
10 germanium oxynitride gate dielectric and processors made with such devices are  
disclosed, as well.